

VN20NSP

HIGH SIDE SMART POWER SOLID STATE RELAY

PRELIMINARY DATA

TYPE	V _{DSS}	R _{DS(on)}	lout	Vcc
VN20NSP	60 V	0.05 Ω	33 A	26 V

- OUTPUT CURRENT (CONTINUOUS): 33A @ T_c=25°C
- 5V LOGIC LEVEL COMPATIBLE INPUT
- THERMAL SHUT-DOWN
- UNDER VOLTAGE SHUT-DOWN
- OPEN DRAIN DIAGNOSTIC OUTPUT
- VERY LOW STAND-BY POWER DISSIPATION

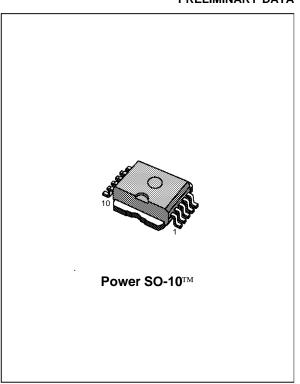
DESCRIPTION

The VN20NSP is a monolithic device made using SGS-THOMSON Vertical Intelligent Power Technology, intended for driving resistive or inductive loads with one side grounded.

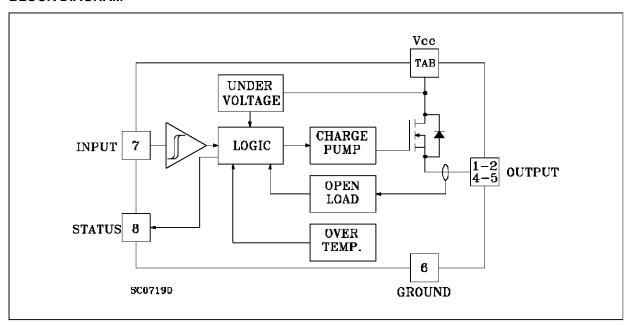
Built-in thermal shut-down protects the chip from over temperature and short circuit.

The input control is 5V logic level compatible.

The open drain diagnostic output indicates open circuit (no load) and over temperature status.



BLOCK DIAGRAM

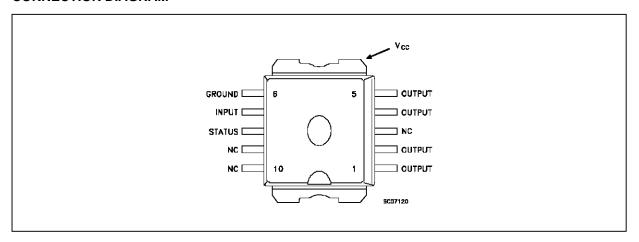


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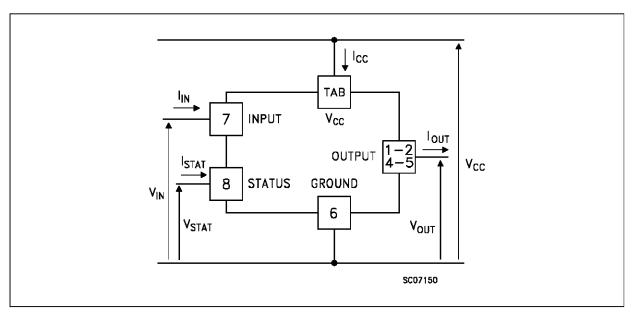
ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	60	V
lout	Output Current (cont.)	33	Α
I _R	Reverse Output Current	-33	Α
I _{IN}	Input Current	±10	mA
-Vcc	Reverse Supply Voltage	-4	V
I _{STAT}	Status Current	±10	mA
V _{ESD}	Electrostatic Discharge (1.5 kΩ, 100 pF)	2000	V
P _{tot}	Power Dissipation at T _c ≤ 25 °C	100	W
Tj	Junction Operating Temperature	-40 to 150	°C
T _{stg}	Storage Temperature	-55 to 150	°C

CONNECTION DIAGRAM



CURRENT AND VOLTAGE CONVENTIONS



THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Max	1.25	°C/W
$R_{thj-amb}$	Thermal Resistance Junction-ambient (\$)	Max	50	°C/W

^(\$) When mounted using minimum recommended pad size on FR-4 board

ELECTRICAL CHARACTERISTICS (V_{CC} = 13 V; -40 \leq T_{j} \leq 125 ^{o}C unless otherwise specified) POWER

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage		7		26	V
Ron	On State Resistance	I _{OUT} = 14 A I _{OUT} = 14 A T _j = 25 °C			0.1 0.05	Ω Ω
Is	Supply Current	$ \begin{array}{ll} \text{Off State} & T_j \geq 25 \ ^{\circ}\text{C} \\ \text{On State} & \end{array} $			50 15	μA mA

SWITCHING

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on Delay Time Of Output Current	I_{OUT} = 14 A Resistive Load Input Rise Time < 0.1 μ s T_j = 25 $^{\circ}$ C		30		μs
t _r	Rise Time Of Output Current	I_{OUT} = 14 A Resistive Load Input Rise Time < 0.1 μ s T_j = 25 $^{\circ}$ C		70		μs
t _{d(off)}	Turn-off Delay Time Of Output Current	I_{OUT} = 14 A Resistive Load Input Rise Time < 0.1 μ s T_j = 25 $^{\circ}$ C		40		μs
t _f	Fall Time Of Output Current	I_{OUT} = 14 A Resistive Load Input Rise Time < 0.1 μ s T_j = 25 $^{\circ}$ C		30		μs
(di/dt) _{on}	Turn-on Current Slope	I _{OUT} = 14 A I _{OUT} = I _{OV}			0.5 2	A/μs A/μs
(di/dt) _{off}	Turn-off Current Slope	I _{OUT} = 14 A I _{OUT} = I _{OV}			2 4	A/μs A/μs

LOGIC INPUT

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VIL	Input Low Level Voltage				0.8	V
V_{IH}	Input High Level Voltage		2		(*)	V
V _{I(hyst.)}	Input Hysteresis Voltage			0.5		V
I _{IN}	Input Current	V _{IN} = 5 V		250	500	μΑ
VicL	Input Clamp Voltage	I _{IN} = 10 mA I _{IN} = -10 mA		6 -0.7		V V

PROTECTIONS AND DIAGNOSTICS

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VSTAT (•)	Status Voltage Output Low	I _{STAT} = 1.6 mA			0.4	V
V _{USD}	Under Voltage Shut Down			6.5		V



ELECTRICAL CHARACTERISTICS (continued)

PROTECTION AND DIAGNOSTICS (continued)

Symbol	Parameter	Test C	Test Conditions			Max.	Unit
V _{SCL} (•)	Status Clamp Voltage	I _{STAT} = 10 mA I _{STAT} = -10 mA			6 -0.7		V V
tsc	Switch-off Time in Short Circuit Condition at Start-Up	$R_{LOAD} < 10 \text{ m}\Omega$	T _c = 25 °C		2	5	ms
lov	Over Current	R_{LOAD} < 10 m Ω	$-40 \le T_c \le 125$ °C			140	Α
I _{AV}	Average Current in Short Circuit	R_{LOAD} < 10 m Ω	$T_c = 85$ °C		2.5		A
loL	Open Load Current Level			5		700	mA
T _{TSD}	Thermal Shut-down Temperature			140			°C
T _R	Reset Temperature			125			°C

^(*) The V_{IH} is internally clamped at 6V about. It is possible to connect this pin to an higher voltage via an external resistor calculated to not exceed 10 mA at the input pin.

FUNCTIONAL DESCRIPTION

The device has a diagnostic output which indicates open circuit (no load) and over temperature conditions. The output signals are processed by internal logic.

To protect the device against short circuit and over-current condition, the thermal protection turns the integrated Power MOS off at a minimum junction temperature of 140 °C. When the temperature returns to about 125 °C the switch is automatically turned on again.

In short circuit conditions the protection reacts with virtually no delay, the sensor being located in the region of the die where the heat is generated.

PROTECTING THE DEVICE AGAINST REVERSE BATTERY

The simplest way to protect the device against a continuous reverse battery voltage (-26V) is to insert a Schottky diode between pin 1 (GND) and ground, as shown in the typical application circuit (fig. 3).

The consequences of the voltage drop across this diode are as follows:

- If the input is pulled to power GND, a negative voltage of -V_F is seen by the device. (V_{IL}, V_{IH} thresholds and V_{STAT} are increased by V_F with respect to power GND).
- The undervoltage shutdown level is increased by V_F.

If there is no need for the control unit to handle external analog signals referred to the power GND, the best approach is to connect the reference potential of the control unit to node [1] (see application circuit in fig. 4), which becomes the common signal GND for the whole control board.

In this way no shift of V_{IH} , V_{IL} and V_{STAT} takes place and no negative voltage appears on the INPUT pin; this solution allows the use of a standard diode, with a breakdown voltage able to handle any ISO normalized negative pulses that occours in the automotive environment.



^(•) Status determination > 100 μs after the switching edge.

TRUTH TABLE

	INPUT	OUTPUT	DIAGNOSTIC
Normal Operation	L H	L H	H H
Open Circuit (No Load)	Н	Н	L
Over-temperature	Н	L	L
Under-voltage	X	L	Н

Figure 1: Waveforms

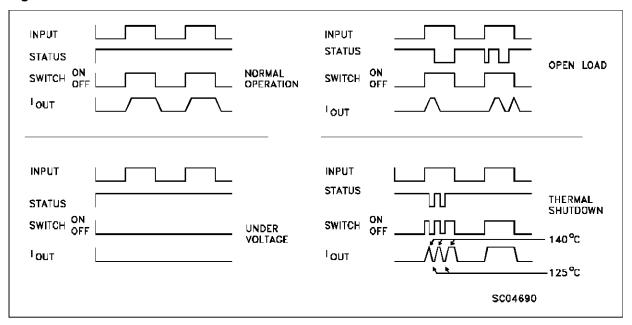


Figure 2: Over Current Test Circuit

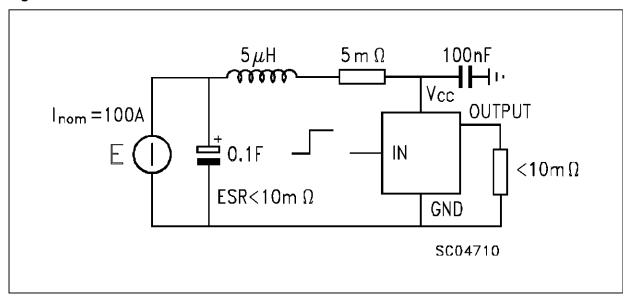


Figure 3: Typical Application Circuit With A Schottky Diode For Reverse Supply Protection

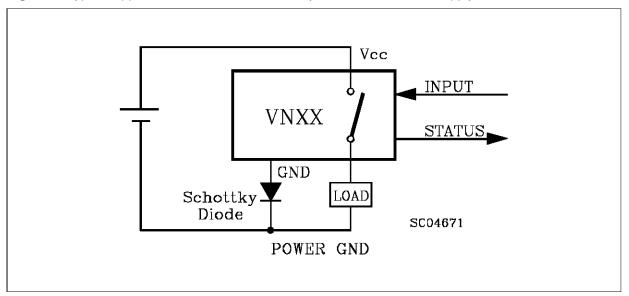
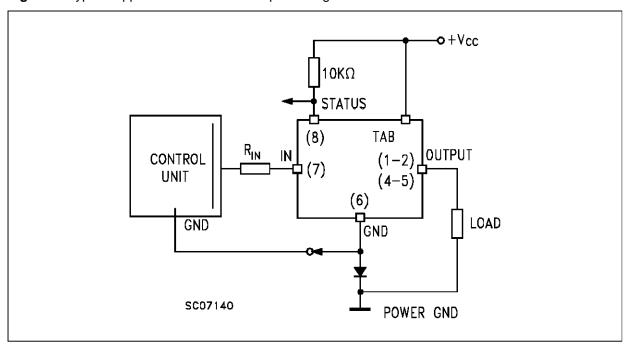
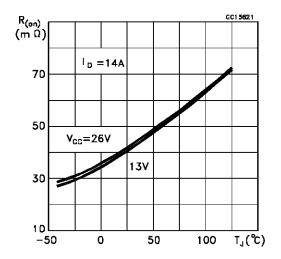


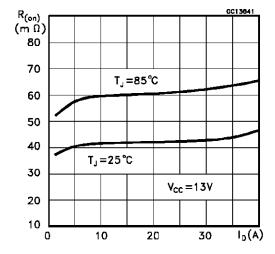
Figure 4: Typical Application Circuit With Separate Signal Ground



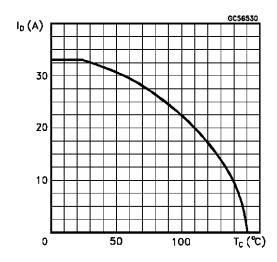
R_{DS(on)} vs Junction Temperature



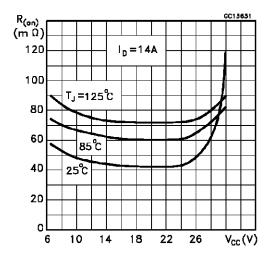
R_{DS(on)} vs Output Current



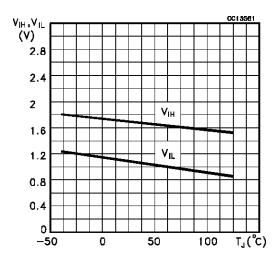
Output Current Derating



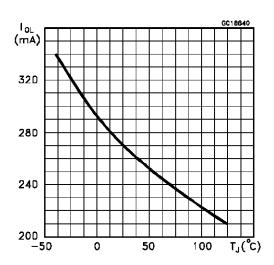
R_{DS(on)} vs Supply Voltage



Input voltages vs Junction Temperature



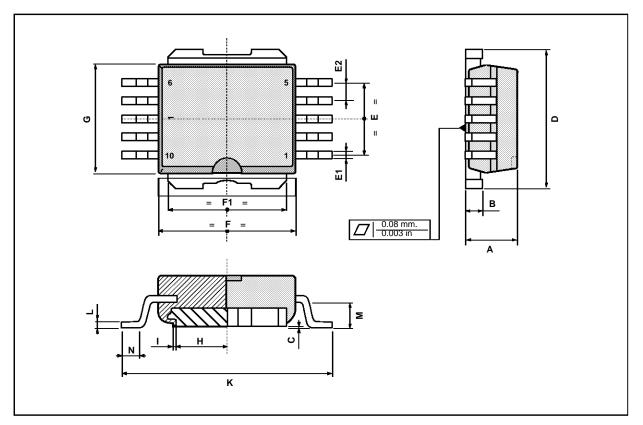
Open Load vs Junction Temperature





Power SO-10 MECHANICAL DATA

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	3.45	3.5	3.55	0.135	0.137	0.140
В		1.28	1.30		0.050	0.051
С			0.15			0.006
D	9.40	9.50	9.60	0.370	0.374	0.378
Е	4.98	5.08	5.48	0.196	0.200	0.216
E1	0.40	0.45	0.60	0.016	0.018	0.024
E2	1.17	1.27	1.37	0.046	0.050	0.054
F	9.30	9.40	9.50	0.366	0.370	0.374
F1	7.95	8.00	8.15	0.313	0.315	0.321
G	7.40	7.50	7.60	0.291	0.295	0.299
Н	6.80	6.90	7.00	0.267	0.417	0.421
I		0.10			0.004	
K	13.80	14.10	14.40	0.543	0.555	0.567
L		0.40	0.50		0.016	0.020
М	1.60	1.67	1.80	0.063	0.066	0.071
N	0.60	0.08	1.00	0.024	0.031	0.039



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